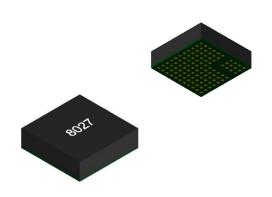


4A Output DC/DC Integrated Plastic-Encapsulated Adjustable Buck Module



2 Applications

- 12V and 42V Automotive and Heavy-Duty Equipment
- 48V Telecommunications Power Supplies
- Avionics and Industrial Control Systems
- Distributed Power Converters

1 Features

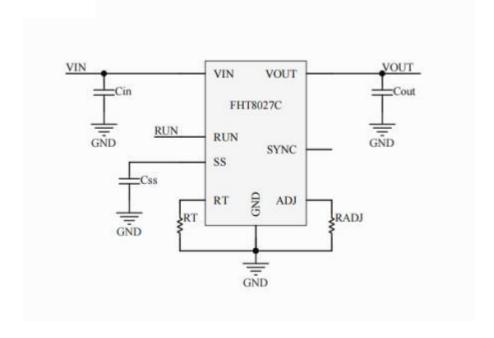
- 4A Full-Load Output Current
- Wide Input Voltage Range: 5V-60V
- Output Voltage: 2.5V-24V
- Selectable Switching Frequency
 Efficiency Up to 95%
- 15µA Shutdown Current
- Programmable Soft-Start
- Compact LGA Package with Low Profile (15mm15mm4.32mm)

3 Description

The FHT8027C is a step-down integrated molded power supply that encapsulates a switching controller, inductor, and related support components within its package. It measures 15.0×15.0×4.32 mm in size.Based on synchronous rectification Buck topology design, it can deliver a maximum output current of 4A. The power conversion efficiency can reach up to 95%. It allows for voltage conversion from 5V to 60V to 2.5V to 24V. Customers can set the switching frequency according to their needs via an external resistor, with a settable frequency range of 100kHz to 1MHz. The soft-start time can be adjusted by a small capacitor.

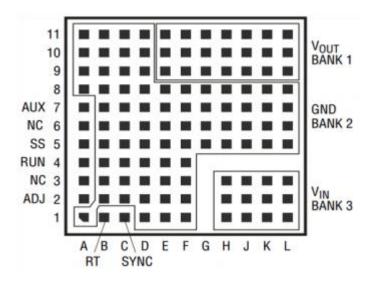
With its integrated small-sized LGA package, only a voltage-regulating resistor, a small number of input and output filter capacitors are required for the peripheral configuration, enabling rapid completion of the power supply system setup.

Typical Applications





Pin Configuration



Pin	Symbol	Description
BANK1	V _{OUT}	Module Voltage Output Pin.
BANK2	GND	Ground Pin.
BANK3	V _{IN}	Module Voltage Input Pin.
A2	ADJ	Voltage Adjustment Pin: Connect a voltage-regulating resistor with an accuracy of over 1% to GND.
A3、A6	NC	Not Connected.
A7	AUX	Internally connected to V _{OUT} , but do not connect it to the Load.
A4	RUN	Control Pin: Grounding this pin can shut down the module. When the voltage at this pin is below 0.4V, the module is in shutdown mode. When the voltage is between 0.4V and 1.2V, the module enters standby mode. When the voltage exceeds 1.2V, the module enters operating mode. Once the voltage rises above 1.2V, an internal 10uA current source is activated, flowing through an external UVLO (Under Voltage Lock Out) resistor divider to create hysteresis. The hysteresis of the RUN pin can be adjusted via external voltage-dividing resistors.
B1	RT	A resistor is connected between this pin and ground to set the switching frequency. Even when using the external SYNC pin to synchronize with an external clock, an RT resistor is still required to be connected.
C1	SYNC	External Clock Input for Synchronizing the Internal Oscillator.
A5	SS	Used to set an external soft-start. The minimum capacitance from SS to AGND is 2.2nF.



Electrical Characteristics

Absolute Maximum Ratings	Condition	Minimum	Nominal Value	Maximum	Unit
VIN , RUN				80	V
SYNC				14	V
ADJ, RT, SS pin voltages				6	V
Storage Temperature		-55		+125	$^{\circ}$
Input Characteristics	Condition	Minimum	Nominal Value	Maximum	Unit
Input Voltage Range		5		60	V

Input Current

Input Current at Full Load	V _{IN} =36V , V _{OUT} =12V , I _{OUT} =4A		1.44		Α
Input Current at Low Voltage and Full Load	V _{IN} =16V , V _{OUT} =12V , I _{OUT} =4A		3.15		Α
Input Current at No Load	V _{IN} =36V , V _{OUT} =12V , I _{OUT} =0A		1		mA
Input Current in Shutdown Mode	ON/OFF=OFF, V _{RUN} =0V			15	μA
General Requirements	Condition	Minimum	Nominal Value	Maximum	Unit
Switching Frequency	Adjusted by R _T Resistor	100		1000	KHz
Efficiency				95	%
Functionality	Condition	Minimum	Nominal Value	Maximum	Unit
RUN Standby to Start Threshold		1.164	1.2	1.236	V
SYNC External Clock Frequency Range	Percentage of Nominal Frequency Set by RT	-50		50	%
Output Characteristics	Condition	Minimum Nominal Value		Maximum	Unit
Output Voltage	Adjusted by the RADJ resistor	2.5		24	V
Line Regulation	V _{OUT} = 12V, 16V < V _{IN} < 60V, I _{LOAD} = 4A			±1	%
Load Regulation	V _{IN} =36V , V _{OUT} =12V,0A < I _{LOAD} ≤ 4A			±1	%
Ripple and Noise	V _{IN} =36V,V _{OUT} =12V,I _{OUT} =4A, C _{Out1} =22uF×4,C _{Out2} =100nF ,20MHz带宽		120		mV
Dynamic Load Response	50-100% ILOAD , di/dt=2A/μS; V _{IN} =36V , V _{OUT} =12V , C _{Out1} =22uF×4 , C _{Out2} =100nF ,		520		mV

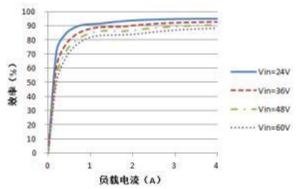
FHT8027C

Structural Characteristics	Condition	Minimum	Nominal Value	Maximum	Unit
Size	15×15×4.32				mm
Weight			3		g
Operating Temperature		-40		125	$^{\circ}$
(Operating Junction Temperature)					
High Temperature Storage	+125℃,48h			125	$^{\circ}$
(Ambient Temperature)					
High Tanananahan On andran	+85℃,24h;			85	°C
High Temperature Operation	8 hours each for low voltage, standard voltage,				C
(Ambient Temperature)	and high voltage input;				
	V _{IN} =60V , V _{OUT} =12V , I _{OUT} =2.4A				
Low Temperature Storage	-55℃, 24h	-55			$^{\circ}$
(Ambient Temperature)					
Low Temperature Operation	-40℃, 24h;	-40			$^{\circ}$
(Ambient Temperature)	8 hours each for low voltage, standard voltage,				
(viriblent remperature)	and high voltage input;				
-	high temperature and high humidity phase:	30		60	°C
Damp Heat	60℃, 95%;				$^{\circ}$
	low temperature and high humidity phase:				
	30℃,95%;				
	10 cycles, with each cycle lasting for 24 hours.				
Thermal Shock	High temperature at 125°C and low temperature at -55°C,	-55		125	$^{\circ}$
	with one hour at each temperature constituting one cycle. The test is conducted for a total of 32 cycles.				

- Note 1: Stress values exceeding those listed in the "Limiting Values" section may cause permanent damage to the device. Prolonged exposure under any absolute maximum rating conditions may affect the reliability and lifespan of the device.
- Note 2: The maximum continuous output current may be derated due to the junction temperature of the FHT8027C.
- Note 3: The performance specifications of the FHT8027C are guaranteed within the entire internal operating temperature range of -40°C to 125°C. Please note that the maximum internal temperature is determined by specific operating conditions, circuit board layout, the rated thermal resistance of the package, and other environmental factors.



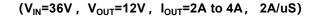
EfficiencyVS Output V_{OUT}=12V

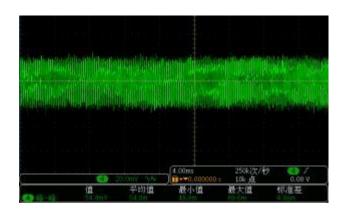


Output Ripple and Noise (V_{IN} =36V, V_{OUT} =12V, I_{OUT} = 4A, C_{out1} =22uF×4, C_{out2}=100nF)

EfficiencyVS Output V_{OUT}=24V 100 90 80 70 60 50 松松 40 30 20 ·-- Vin=60V 10 0 负载电流(A)

Dynamic Load Response

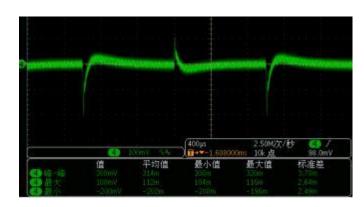




Output Start-up Delay Time Waveform









Operation

Output Voltage Setting

The output voltage of this module can be set by an external resistor RADJ connected to the ADJ pin. The reference calculation formula is as follows:

$$R_{ADJ}(k\Omega) = \frac{399.2}{V_{OUT} - 0.8}$$

Note: It is recommended to reserve two resistor positions for fine-tuning the output voltage.

Soft Start

The soft start function controls the rise slope of the power supply's output voltage during startup. The controlled output voltage slope minimizes output voltage overshoot and reduces input inrush current. A capacitor connected between the SS pin and GND is used to set the rise slope. The soft start time (tSS) is set by the CSS capacitor, using the following formula:

$$C_{SS} = \frac{10\mu A \bullet t_{SS}}{0.8V}$$

The soft start capacitor needs to be greater than 2.2nF.

Operating Frequency

The switching frequency can be adjusted by a resistor connected between the RT pin and ground, or synchronized to an external clock signal through the SYNC pin.

The switching frequency range adjustable by the RT resistor is from 100 kHz to 1 MHz. The

$$R_{RT}(k\Omega) = \frac{10^4}{f_{SW}(kHz)}$$

formula for calculating the RT value is as follows:

Synchronization

In CCM mode, the oscillator can be synchronized to an external clock through the SYNC pin. The requirements for the external clock signal are as follows: the clock range is from 100 kHz to 1 MHz; the clock frequency range is -50% to +50% of the nominal frequency set by RT; the maximum voltage amplitude of the clock is 13V; and the minimum pulse width of the clock is 50 ns.

Operating Modes

PFM: When the SYNC pin is connected to low level, the module operates in PFM (Pulse Frequency Modulation) mode under light load conditions. In PFM mode, as the load current decreases, the switching frequency also decreases, thereby improving efficiency at light loads by reducing switching losses. Conversely, when the load current increases, the switching frequency increases to minimize output voltage ripple.

FCC: When the SYNC pin is connected to high level, the module maintains Continuous Conduction Mode (CCM) under light load conditions. In FCC mode, the switching frequency remains almost constant across the entire load range, making it suitable for applications that require tight control of switching frequency at the cost of lower efficiency.



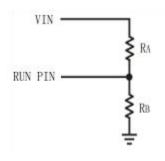
Input UVLO

The FHT8027C supports adjustable input UVLO with hysteresis that can be tailored to specific power-up and power-down requirements through the resistor divider connected to the RUN pin. When the RUN pin voltage exceeds 1.2V, an additional 10µA of hysteresis is added. This extra current contributes to the hysteresis of the input voltage. The formulas for calculating the input start-up voltage and the external hysteresis of the input voltage are as follows:

$$R_{A}(\Omega) = \frac{V_{STR} - V_{STOP}}{10uA}$$

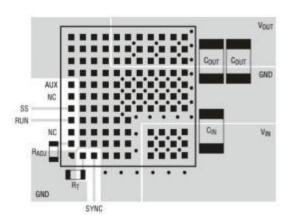
$$R_{B}(\Omega) = R_{A} \times \frac{1.2V}{V_{STR} - 1.2V}$$

The application circuit is illustrated in the figure of the undervoltage lockout (UVLO) voltage divider.



Undervoltage lockout (UVLO) voltage divider circuit

Layout



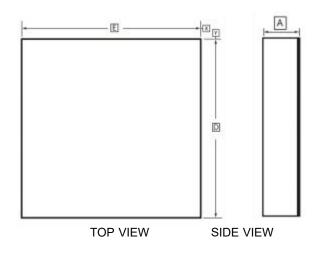
It is essential to ensure that the grounding and heat dissipation methods are acceptable. Here are a few key rules to keep in mind:

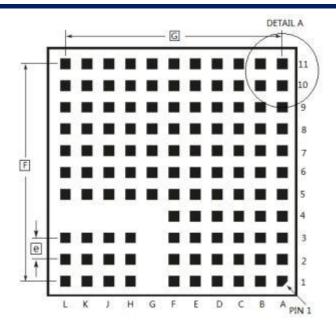
- Place the R_{ADJ} and RT resistors as close as possible to their respective pins.
- 2. Position the C_{IN} capacitor as close as possible to t he V_{IN} and GND connections of the FHT8027C.
- 3. Layout the C_{OUT} capacitor as close as possible to the V_{OUT} and GND connections of the FHT8027C.
- 4. Route C_{IN} and C_{OUT} so that their grounding currents flow close to or underneath the FHT8027C.
- 5 .Connect all GND lines to a large copper pour or plane on the top layer. Avoid disruptions in the grounding connections between external components and the FHT8027C.



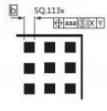
LGA Package

113 Pin (15mm×15mm×4.32mm)





BOTTOM VIEW



DETAIL A

NOTES:

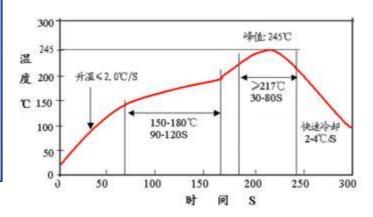
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M- 1994
- 2.ALL DIMENSIONS ARE IN MILLIMETERS

DIMENSIONS						
SYMBOL	MIN	NOM	MAX			
A	4.22	4.32	4.42			
b	0.61	0.635	0.66			
D	14.8	15	15.2			
E	14.8	15	15.2			
e						
F	12.70					
G	12.70					
aaa			0.05			



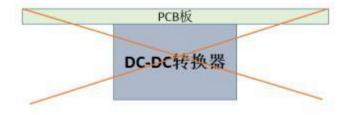
Soldering and Storage Precautions

Recommended Reflow Soldering Profile



Precautions:

1.Due to the large size of the module, please do not place it on the bottom side of the board during reflow soldering to prevent it from falling off.



- 2. For bulk and unpacked products, store them in a desiccator (with a relative humidity of less than 10% inside). For products still in their original packaging, it is also recommended to store them in a desiccator if possible.
- 3. Before mounting the module on the board, it is necessary to strictly follow the baking conditions: bake the samples at 125°C for more than 48 hours and control the reflow soldering temperature within 245°C.